

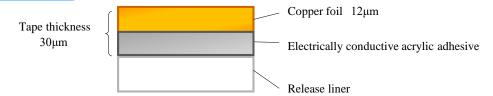




Electrically conductive copper foil adhesive tape



Construction



Characteristic

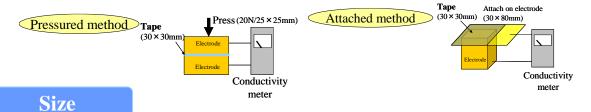
- Tape thickness is 30μm.
- Excellent electrical conductivity in thickness direction.
- Excellent adhesive strength.

Application

For EMI shielding of electronic equipment.

Property

	Units	E30CU
Tape thickness	μm	30
Adhesion (SUS)	N/25mm	11.0
Electrical Conductivity: Pressure Method	$\Omega/6.25$ c m $^{\circ}$	0.01
Electrical Conductivity :Attached Method	$\Omega/6.25$ c m 2	0.02
Holding power: 70°C 0.5kg	h	24<



1000mm in max width / 50m in length

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